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<ul> <li>Package Options Include Plastic Small Outline Packages, Both Plastic and Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs</li> </ul>	SN54AS877 JT PACKAGE SN74AS877 DW OR NT PACKAGE (TOP VIEW)
<ul> <li>Buffered 3-State Outputs Drive Bus Lines Directly</li> </ul>	S0[ 1  24 ] V <sub>CC</sub> S1[ 2  23 ] CLK S2[ 3  22 ] SERIN
Cascaded to n-Bits	A1 4 21 B1
Eight Selectable Transceiver/Port	
Functions:	A3 🛛 6 🛛 19 🗍 B3
A to B or B to A	A4 🛛 7 18 🗍 B4
Register to A or Register to B	A5 🛛 8 17 🗍 B5
Shifted to A or Shifted to B	A6[] 9 16[] B6
Off-Line Shifts (A and B Ports in	A7[10 15]B7
High-Impedance State)	A8[11 14] B8
Register Clear	GND [ 12 13 ] Q8
Particularly Suitable for Use in Signature	
Analysis Circuitry	SN54AS877JT PACKAGE
Serial Register Provides:	SN74AS877 DW OR NT PACKAGE
Parallel Storage of Either A or B Input	(TOP VIEW)
Data	O X Z
Serial Transmission of Data from Either A or B Port	S S S S S S S S S S S S S S S S S S S
Dependable Texas Instruments Quality and Reliability	A1 5 4 3 2 1 28 27 26 25 B1

#### description

Reliability

The 'AS877 features two 8-bit I/O ports (A1-A8 and B1-B8), an 8-bit parallel-load, serial-in, parallel-out shift register, and control logic. With these features, this device is capable of performing eight selectable transceiver or port functions, depending on the state of the three select lines S0, S1, and S2. These functions include: transferring data from port A to port B or vice versa (i.e., the transceiver function), transferring data from the register to either port

vice versa (i.e., the transceiver function), transferring data from the register to either port, serial shifting data to either port, performing off-line shifts (with A and B ports in high-impedance state), and clearing the register. Synchronous parallel loading of the internal register can be accomplished from either port on the positive transition of the clock while serially shifting data in via the SERIN input. The 'AS877 is ideally suited for applications needing signature-analysis circuitry to enhance system verification and/or fault analysis. All serial data is shifted right. All outputs are buffer-type outputs designed specifically to drive bus lines directly and all are 3-state except for Q8, which is a totem-pole output.

A2

A3 🛛 7

NC 18

A4 🛛

A5 🗍 10

A6 1 11

6

9

A7 A8

12 13 14 15 16 17 18

92

Q8 B3 B7

GND

NC - No internal connection

The SN54AS877 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74AS877 is characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C.



B2

23 🛛 B3

22 NC

B4

B5

19**∏** B6

24

21

20 T

FUNCTION TABLE

	MODE		CLOCK	SERIN	A1	Q1	B1	A2	Q2	B2	A3	Q3	В3	A4	Q4	В4	A5	Q5	В5	A6	Q6	B6	A7	Q7	B7	A8	Q8	B8	PORT FUNCTIO
S2	S1	S0										_			-														FONCTIO
L	L	L	H or L	Х	Z	Qn	A1	Z	Qn	A2	Z	Qn	A3	Z	Qn	Q4	Z	Qn	A5	Z	Qn	Q6	Z	Qn	Q7	Z	Qn	A8	A To B
L	L	L	Ŷ	х	Z	A1	A1	z	A2	A2	z	A3	A3	z	A4	Q4	Z	Q5	A5	z	A6	Q6	z	A7	Q7	Z	A8	A8	AIOD
L	L	Н	H or L	Х	B1	Qn	Z	B2	Qn	Z	B3	Qn	Z	B4	Qn	Z	B5	Qn	Z	B6	Qn	Z	B7	Qn	Z	B8	Qn	Z	D.T. 4
L	L	н	Ŷ	х	B1	B1	Z	B2	B2	Ζ	В3	B3	Z	B4	B4	Z	B5	B5	Z	B6	B6	Z	B7	B7	Ζ	B8	B8	Z	B To A
L	Н	L	H or L	Х	Х	Qn	Q1	Х	Qn	Q2	Х	Qn	Q3	Х	Qn	Q4	Х	Qn	Q5	Х	Qn	Q6	Х	Qn	Q7	Х	Qn	Q8	0 T D
L	н	L	Ŷ	х	z	A1	A1	z	A2	A2	z	A3	A3	z	A4	A4	z	A5	A5	z	A6	A6	z	A7	A7	z	A8	A8	Q <sub>N</sub> To B
L	Н	Н	H or L	Х	Q1	Qn	Х	Q2	Qn	Х	Q3	Qn	Z	Q4	Qn	Z	Q5	Qn	Х	Q6	Qn	Ζ	Q7	Qn	Z	Q8	Qn	Х	
L	н	н	Ŷ	х	B1	B1	Ζ	B2	B2	Ζ	В3	B3	Z	В4	B4	Z	B5	B5	Z	B6	B6	Z	B7	B7	Ζ	B8	B8	Z	Q <sub>N</sub> To A
Н	L	L	H or L	Х	Ζ	Qn	Q1	Z	Qn	Q2	Q3	Qn	Q3	Z	Qn	Q4	Z	Qn	Q5	Z	Qn	Q6	Z	Qn	Q7	Z	Qn	Q8	Shift
н	L	L	$\uparrow$	н	z	н	н	z	Q1	Q1	Q2	Q2	Q2	z	Q3	Q3	z	Q4	Q4	z	Q5	Q5	z	Q6	Q6	z	Q7	Q7	То
н	L	L	Ŷ	L	z	L	L	z	Q1	Q1	Q2	Q2	Q2	z	Q3	Q3	z	Q4	Q4	z	Q5	Q5	z	Q6	Q6	z	Q7	Q7	В
Н	L	Н	H or L	Х	Q1	Qn	Z	Q2	Qn	Z	Q3	Qn	Z	Q4	Qn	Z	Q5	Qn	Z	Q6	Qn	Ζ	Q7	Qn	Z	Q8	Qn	Z	Shift
н	L	н	$\uparrow$	н	н	н	Z	Q1	Q1	Z	Q2	Q2	z	Q3	Q3	Z	Q4	Q4	Z	Q5	Q5	Z	Q6	Q6	z	Q7	Q7	z	То
н	L	н	Ŷ	L	L	L	Z	Q1	Q1	Ζ	Q2	Q2	Z	Q3	Q3	Z	Q4	Q4	Z	Q5	Q5	Z	Q6	Q6	Ζ	Q7	Q7	Z	А
Н	Н	L	H or L	Х	Ζ	Qn	Z	Z	Qn	Z	Z	Qn	Z	Z	Qn	Q4	Z	Qn	Z	Z	Qn	Q6	Z	Qn	Q7	Z	Qn	Z	
н	н	L	$\uparrow$	н	z	н	Z	z	Q1	Z	z	Q2	Z	z	Q3	Q3	z	Q4	Z	z	Q5	Q5	z	Q6	Q6	z	Q7	Z	Shift
н	н	L	Ŷ	L	z	L	Z	z	Q1	Z	z	Q2	Z	z	Q3	Q3	z	Q4	z	z	Q5	Q5	z	Q6	Q6	z	Q7	Z	
Н	Н	Н	H or L	Х	Z	Qn	Z	Z	Qn	Ζ	Z	Qn	Z	Z	Qn	Z													
н	н	н		н	z	н	Z	z	L	z	z	L	z	z	L	z	z	L	z	z	L	z	z	L	z	z	L	Z Clear	

SN54AS877, SN74AS877 8-BIT UNIVERSAL TRANSCEIVER PORT CONTROLLERS

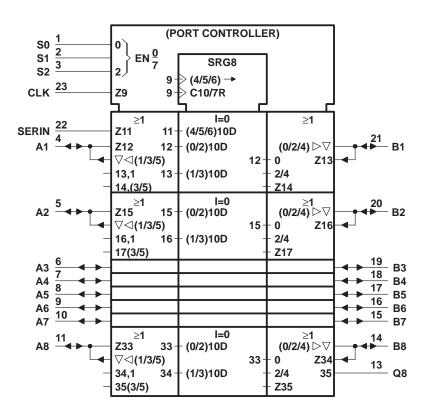
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 $n = level Of Q_n(n = 1, 2...8)$  established on most recent transition of CLK. Q1 thru Q8 are the shift register outputs; only Q8 is available externally. The double inversions that take place as data travels from port to port are ignored in this table.

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logic symbol †

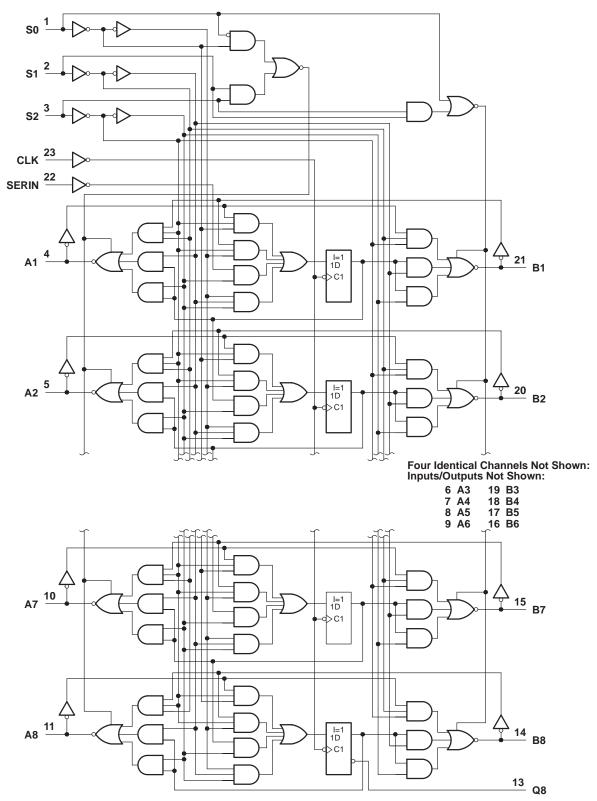


<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, JT, and NT packages.



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#### logic diagram (positive logic)



Pin numbers shown are for DW, JT, and NT packages.



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### absolute maximum ratings over free-air temperature range

Voltage applied to a disabled 3-state or	utput	5.5 V
Operating free-air temperature range:	SN54AS877	–55°C to 125°C
	SN74AS877	0°C to 70°C
Storage temperature range		−65°C to 150°C

#### recommended operating conditions

			SI	154AS87	7	SN	174AS87	7	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.8			0.8	V
1		A1-A8, B1-B8			-12			-15	A
IOH High-level input voltage		Q8			-2			-2	mA
IOL	Low-level input voltage	A1-A8, B1-B8			32			48	mA
		Q8			20			20	
fclock	Clock frequency		0		45	0		50	MHz
tw	Pulse duration, CLK		11			10			ns
t <sub>su</sub>	Setup time before CLK↑	A1-A8, B1-B8 SERIN	5.5			5.5			ns
		S0, S1, S2	5.5			5.5			
t <sub>h</sub>	Hold time, data after CLK↑	A1-A8, B1-B8 SERIN	0			0			ns
		S0, S1, S2	0			0			
TA	Operating free-air temperature		-55		125	0		70	°C



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#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED		TEAT OON		SN	54AS87	7	SN	74AS87	7		
•	PARAMETER	TEST CON	DITIONS	MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT	
VIK		V <sub>CC</sub> = 4.5 V,	lj = – 18 mA			-1.2			-1.2	V	
	A1-A8	V <sub>CC</sub> = 4.5 V,	$I_{OH} = -12 \text{ mA}$	2	3.2						
VOH	B1-B8	V <sub>CC</sub> = 4.5 V,	I <sub>OH</sub> = -15 mA				2	3.3		V	
	All outputs	$V_{CC}$ = 4.5 V to 5.5 V,	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2			V <sub>CC</sub> -2				
	All outputs	V <sub>CC</sub> = 4.5 V,	I <sub>OL</sub> = 32 mA		0.25	0.5					
VOL	except Q8	$V_{CC} = 4.5 V,$	I <sub>OL</sub> = 48 mA					0.35	0.5	V	
	Q8	V <sub>CC</sub> = 4.5 V,	I <sub>OL</sub> = 20 mA		0.25	0.5		0.25	0.5		
	S0, S1, S2		\/, <b>7</b> \/			0.3			0.3		
lj –	CLK and SERIN	$V_{CC} = 5.5 V,$	$V_{I} = 7 V$			0.1			0.1	mA	
	A1-A8, B1-B8	V <sub>CC =</sub> 5.5 V,	V <sub>I</sub> = 5.5 V			0.2			0.2		
	S0, S1, S2					60			60		
Iн	CLK and SERIN	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μΑ	
	A1-A8, B1-B8‡					70			70		
	S0, S1, S2					-1			-1		
ΙL	CLK and SERIN	V <sub>CC</sub> = 5.5 V,	$V_{I} = 0.4 V$			-0.5			-0.5	mA	
	A1-A8, B1-B8					-0.75			-0.75		
IOġ	Except Q8		V = - 2.25 V	-30		-112	-30		-112	mA	
102	Q8	V <sub>CC</sub> = 5.5 V,	vO = 2.25 v	-20		-112	-20		-112	ШA	
ICC		VCC = 5.5 V			136	220		136	220	mA	

<sup>†</sup> All typical values are at V<sub>CC</sub> = 5 V,  $T_A = 25^{\circ}C$ . <sup>‡</sup> For I/O ports, the parameters I<sub>IH</sub> and I<sub>IL</sub> include the output currents I<sub>OZH</sub> and I<sub>OZL</sub>, respectively.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



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switching characteristics (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54	$V_{CC} = 4.$ $C_L = 50$ R1 = 500 R2 = 500 $T_A = MIN$ AS877	pF, 0 Ω, 0 Ω, 1 to MAX SN74A	S877	UNIT
			MIN	MAX	MIN	MAX	
f <sub>max</sub>			45		50		MHz
<sup>t</sup> PLH	Any A port	Any B port	2	8.5	2	7	ns
<sup>t</sup> PHL		Any B port	3	10.5	3	9	110
<sup>t</sup> PLH	Any P port	Any A port	2	9	2	7.5	
<sup>t</sup> PHL	Any B port	Any A port	3	10.5	3	9	ns
<sup>t</sup> PLH	S0 S1 S2 T	Any A or B	2	11.5	2	10	
<sup>t</sup> PHL	S0, S1, S2 Ť	port	3	9.5	3	8	ns
<sup>t</sup> PLH	<u>C</u> LL	Any A or B	2	11	2	9	
<sup>t</sup> PHL	CLk	port	3	13	3	11.5	ns
<sup>t</sup> PLH		0.0	2	10.5	2	8	
<sup>t</sup> PHL	CLK	QB	3	10	3	8.5	ns
<sup>t</sup> PHZ			2	7.5	2	6.5	
<sup>t</sup> PLZ	S0, S1, S2 †	Any A or B	3	13	3	10.5	ns
<sup>t</sup> PZH	30, 31, 32 1	port	2	9	2	7	00
<sup>t</sup> PZL			3	11.5	3	9.5	ns

NOTE 1: Load circuit and voltage waveforms are shown in Section 1.

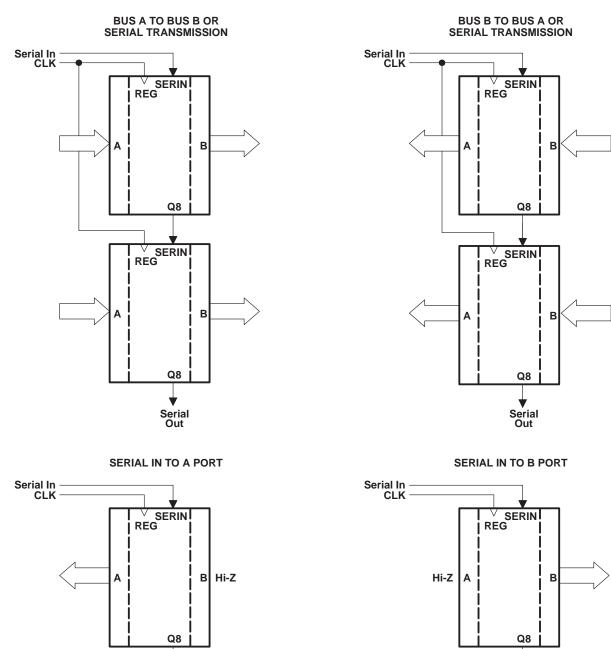
<sup>†</sup> The positive transition of S2 will cause low-level data at the A output Bus or stored in the shift register to be invalid for 12 ns.



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Serial Out

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#### **TYPICAL APPLICATION DATA**



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Serial Out

#### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74AS877DW	OBSOLETE	SOIC	DW	24	TBD	Call TI	Call TI
SN74AS877NT	OBSOLETE	PDIP	NT	24	TBD	Call TI	Call TI
SN74AS877NT	OBSOLETE	PDIP	NT	24	TBD	Call TI	Call TI
SN74AS877NT	OBSOLETE	PDIP	NT	24	TBD	Call TI	Call TI

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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